

SMD Top View Package LED SMTL3020GC, Green



SMTL3020GC

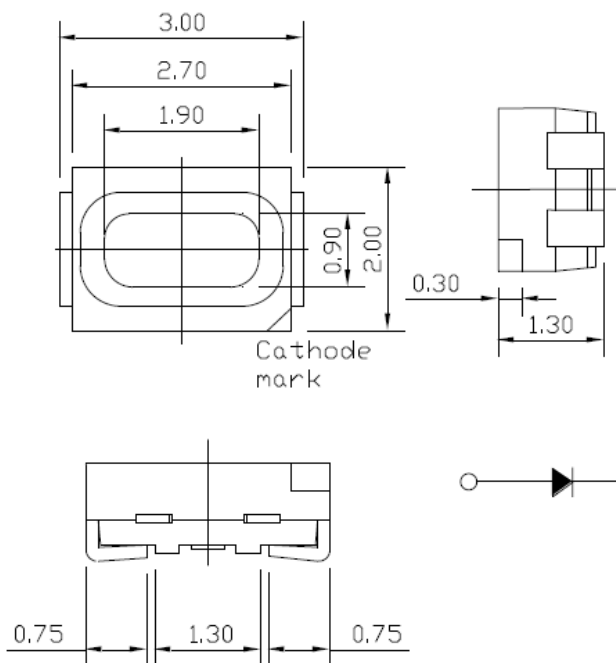
- ◆ Industry Standard PLCC Footprint
- ◆ Low Profile Package
- ◆ High Luminous Intensity
- ◆ Wide Viewing Angle
- ◆ High Power Efficiency



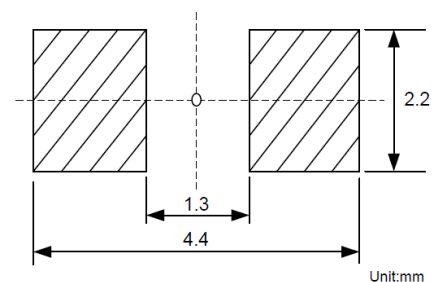
Bivar SMTL3020 LED is offered in an industry standard PLCC package with high luminous intensity and wide viewing angles. The miniature package is ideal for small scale applications such as illumination, general indication, and backlighting. Low power consumption and excellent long-life reliability are suitable for battery powered equipment. The robust package is ideal for harsh working environments and can be used in clusters for high luminous applications. Wide variety of color and intensity combinations are available to meet any illumination needs. Bivar SMTL3020 LED is packaged in standard tape and reels for pick and place assemblies.

Part Number	Emitted Color	Dominant Wavelength (nm)	Luminous Intensity Typ. mcd	Lens Color	Viewing Angle
SMTL3020GC	Green	528	1050	Water Clear	120°

Outline Dimensions



The following soldering patterns are recommended for reflow soldering .



Outline Drawings Notes:

1. All dimensions are in millimeter [inches]
2. Standard tolerance: ± 0.010 " (0.25mm) unless otherwise noted.

Bivar reserves the right to make changes at any time without notice.

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Absolute Maximum Ratings

T_A = 25°C unless otherwise noted

Power Dissipation	95 mW
Continuous Forward Current (DC)	30 mA
Pulse Current ¹	80 mA
Electrostatic Discharge Classification (HBM)	+/- 500V
Reverse Voltage	5 V
Shelf Life	1 year
Operating Temperature Range	-40°C ~ +85°C
Storage Temperature Range	-55°C ~ +100°C
Lead Soldering Temperature	245°C for 10 sec.

Notes: 1. 10% Duty Cycle, Pulse Width ≤ 0.1 msec. 2. Solder time less than 10 seconds at maximum temperature.

Handling: (1) Reflow soldering must not be performed more than twice. Hand soldering must not be performed more than once.

(2) Sensitive to static electricity or surge voltage. Proper handling required to avoid ESD damage and impair LED reliability.

Electrical / Optical Characteristics

T_A = 25°C & I_F = 20 mA unless otherwise noted

Emitting Color	Forward Voltage (V) ¹			Recommended Forward Current (mA)			Reverse Current (μA) @ V _R =5V	Dominant Wavelength (nm) ²			Luminous Intensity I _v (mcd) ³			Viewing Angle 2Θ ½ (deg)
	MIN	TYP	MAX	MIN	TYP	MAX	MAX	MIN	TYP	MAX	MIN	TYP	MAX	TYP
Green	2.8	3.2	3.6	/	20	/	10	520	528	535	500	1050	1550	120

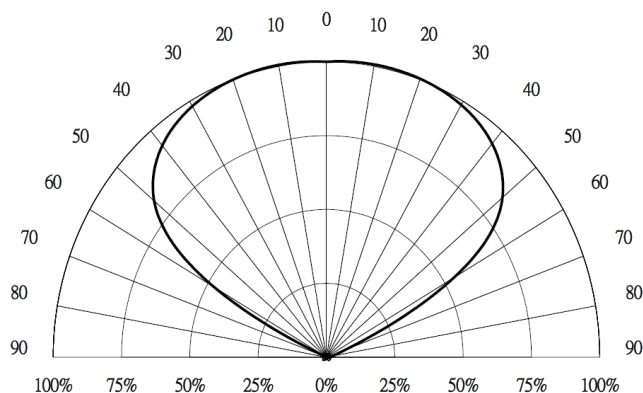
Notes: 1. Tolerance of forward voltage: ±0.05V.

2. Tolerance of dominant wavelength: -1.0nm of MIN & +1nm of MAX.

3. Tolerance of luminous intensity: ±10%

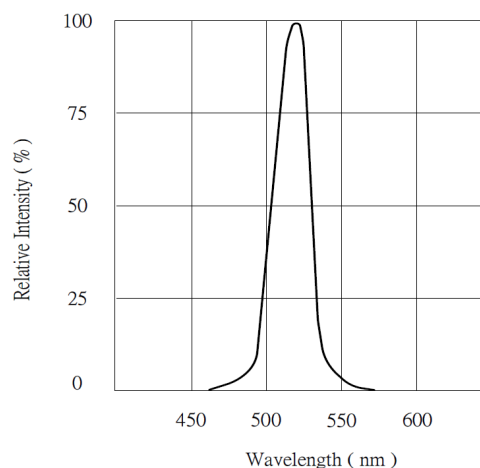
Directivity Radiation

T_A = 25°C unless otherwise noted



Radiation Diagram

Relative Intensity vs Wavelength



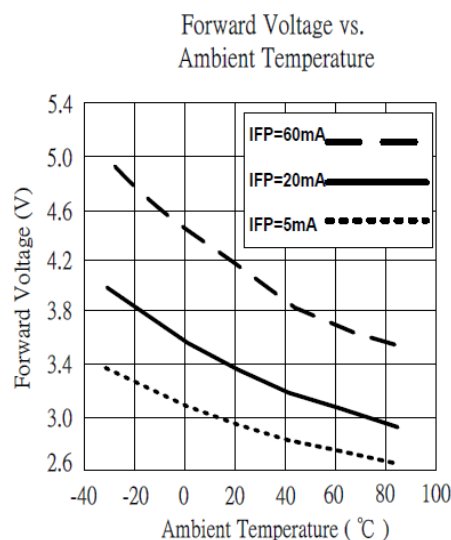
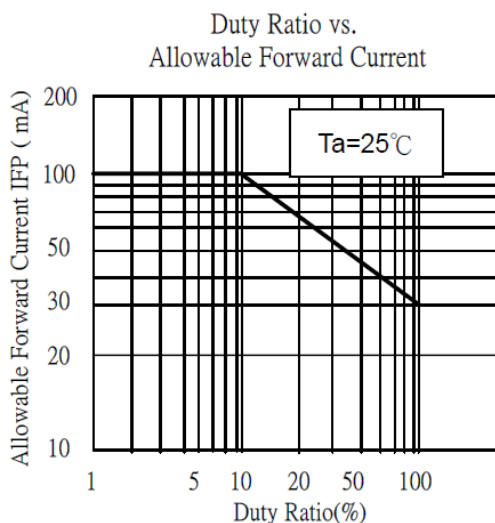
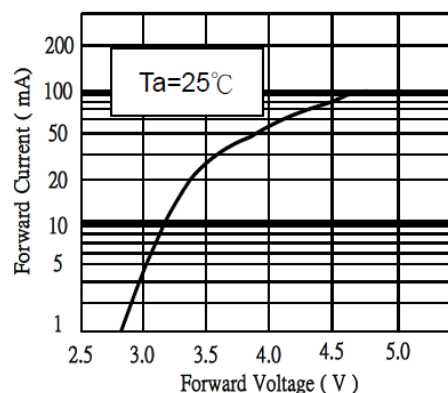
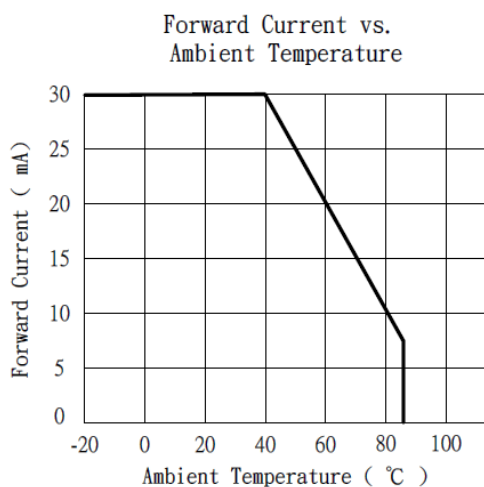
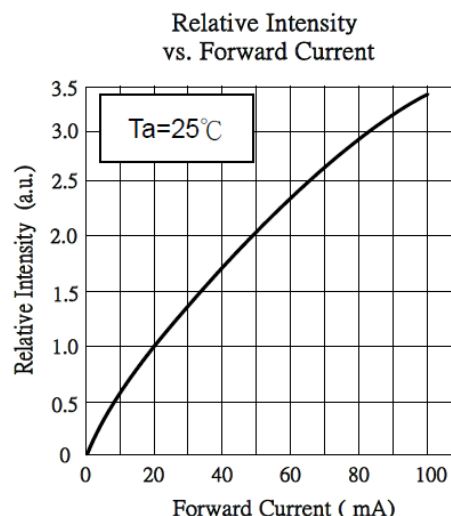
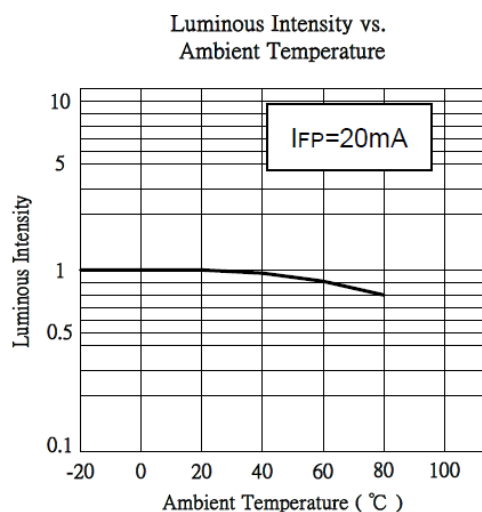
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BIVAR

Typical Electrical / Optical Characteristics Curves

T_A = 25°C unless otherwise noted



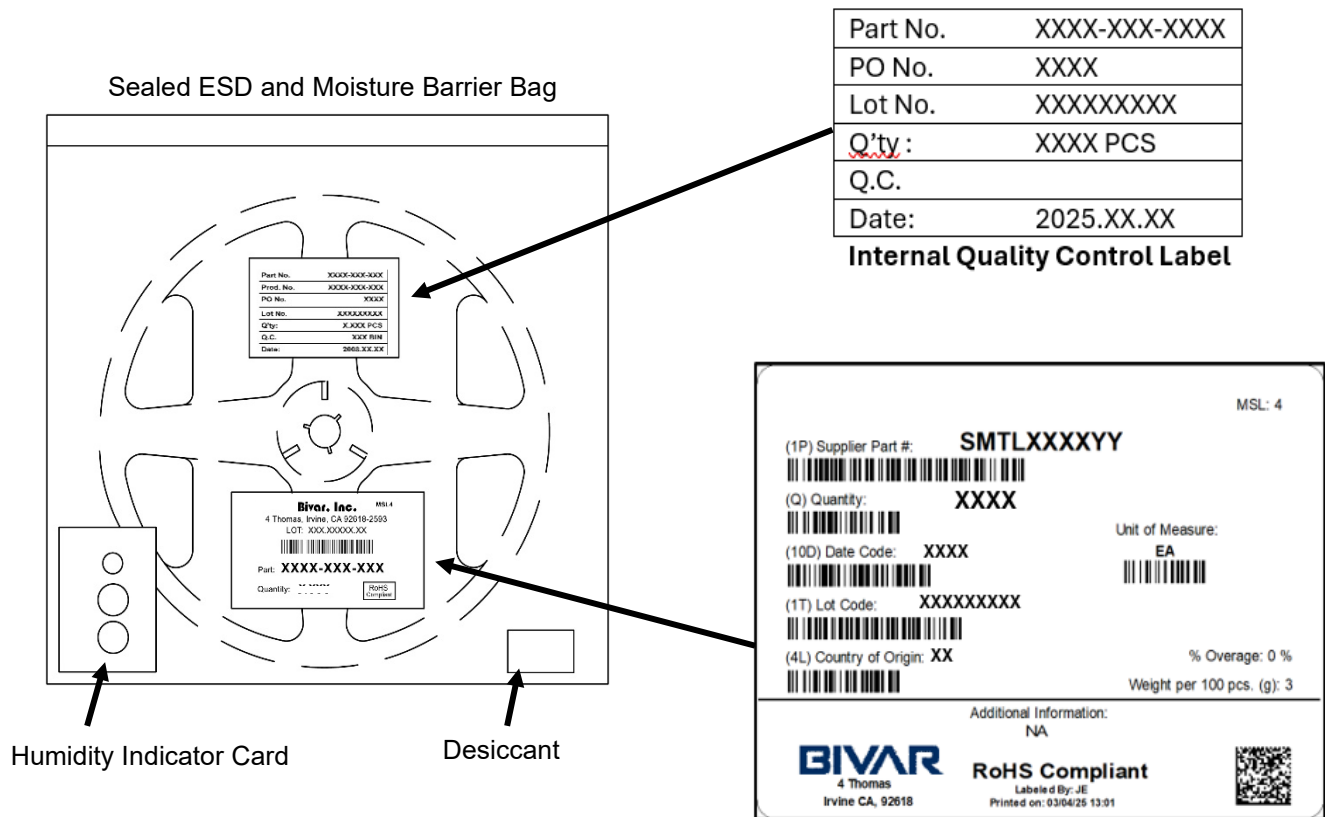
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Packaging and Labeling Plan

Note: 1 Reel / Bag



Storage:

Before Opening the Package: The LEDs should be kept at 30°C or less and 90% RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.

After Opening the Package: The LEDs should be kept at 30°C or less and 70% RH or less. The LEDs should be soldered within 72 hours (3 days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following condition: BAKE TREATMENT – more than 24 hours at 65 +/-°C. LED electrode sections are comprised of silver-plated copper alloy. The silver surface may be affected by the environment which main contain corrosive gases and so on. Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the user uses the LEDs as soon as possible. Avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

Moisture Proof Package:

When moisture is absorbed into the SMT package, it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep the moisture to a minimum in the package.

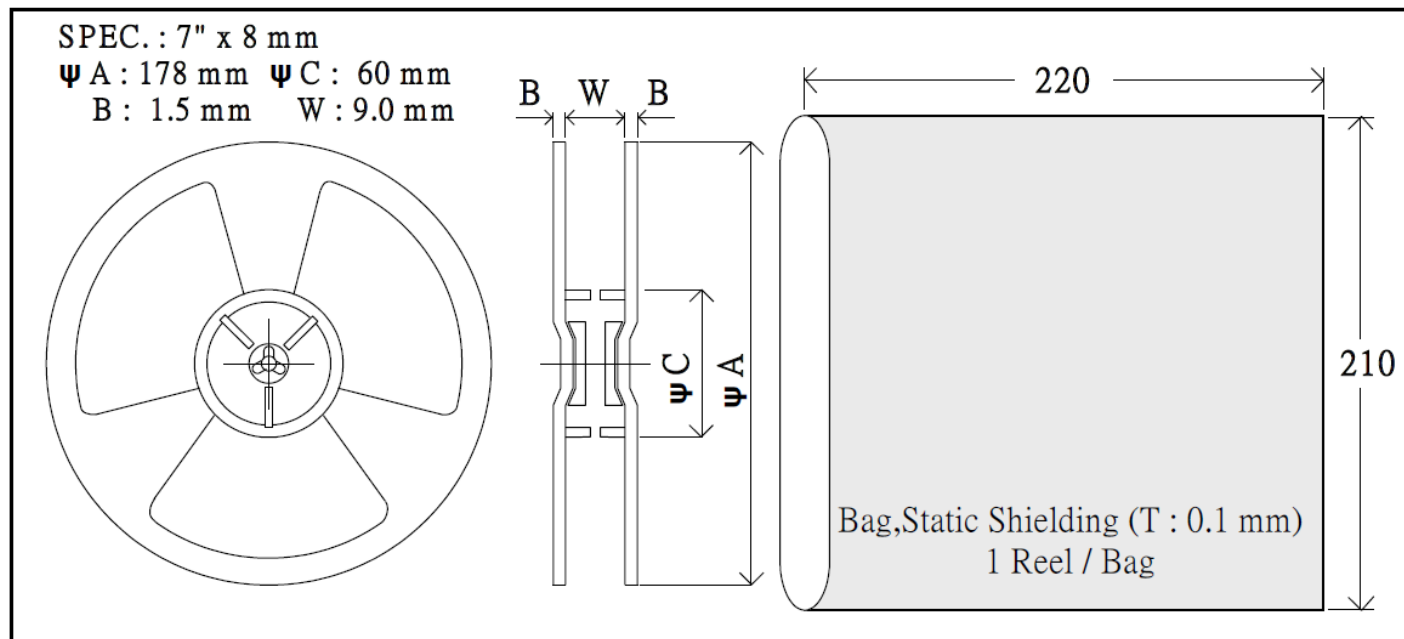
The moisture proof package is made of an aluminum moisture proof bag with a zipper. A package of a moisture absorbent material (silica gel) is inserted into the aluminum moisture proof bag. The silica gel changes its color from blue to pink as it absorbs moisture.

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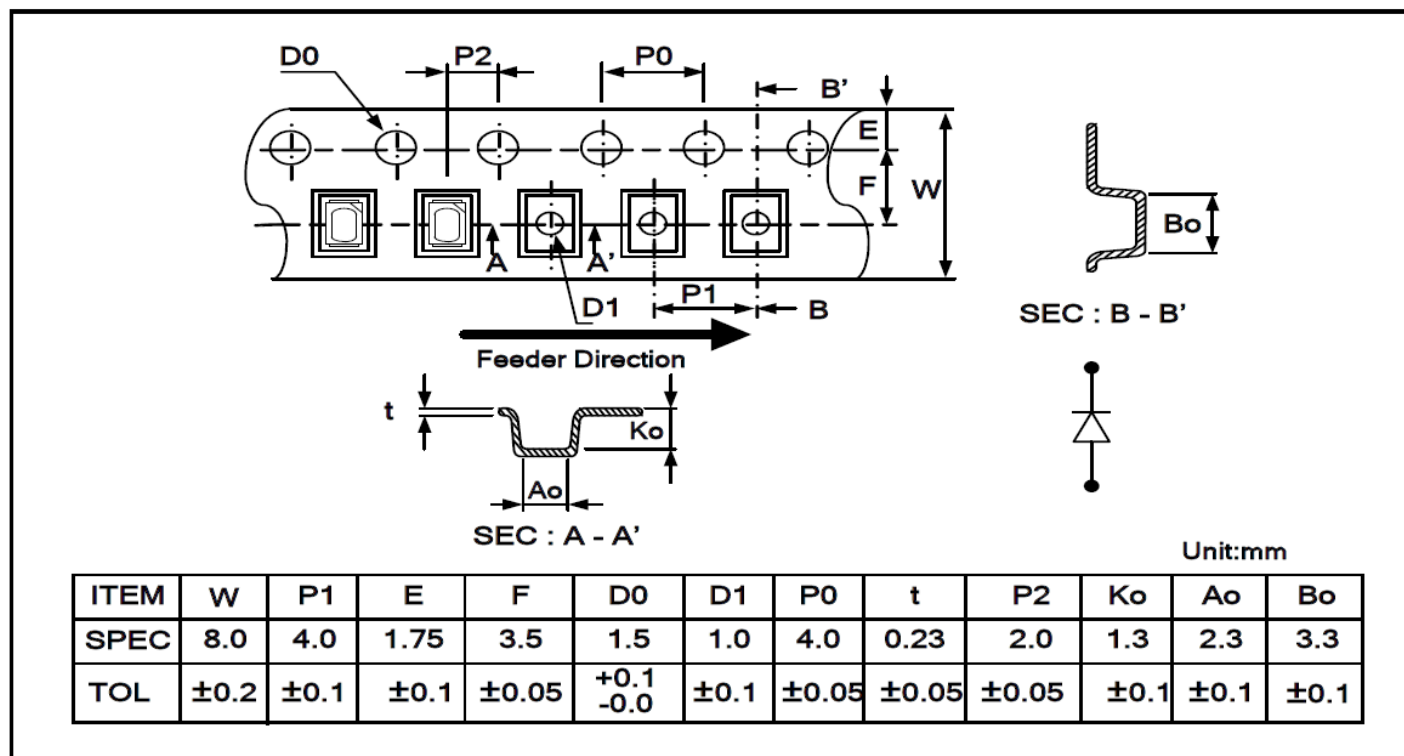
Tape and Reel Dimensions

Note: 2000 pcs/Reel

Package Reel & Static Shielding Bag Dimensions :

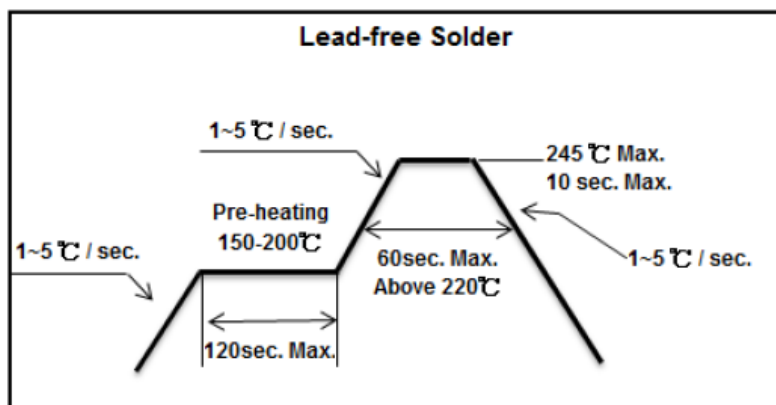


Package Carrier Tape Dimensions : 2,000 pcs/Reel



Recommended Soldering Conditions – Time Profile (Reflow Soldering)

Lead Free Solder	
Pre-heat	150~200 °C
Pre-heat time	120 sec. Max.
Peak-Temperature	245 °C Max.
Soldering time Condition	10 sec. Max.



Surface Mounting Condition

In automatic mounting of the SMD LEDs on printed circuit boards, any bending, expanding and pulling forces or shock against the SMD LEDs shall be kept minimum to prevent them from electrical failures and mechanical damages of the device.

Soldering Reflow

Soldering of the SMD LEDs shall conform to the soldering conditions in the individual specifications. SMD LEDs are designed for Reflow Soldering. In the reflow soldering, too high temperature and too large temperature gradient such as rapid heating/cooling may cause electrical and optical failure and damage of the devices. Bivar cannot guarantee the LED after they have been assembled using the solder dipping method.

CAUTIONS:

Heat Management & Design Considerations

*** Heat generation must be controlled during LED use. The temperature of the chips is affected by the thermal resistance of the PCB and LED density configuration.

*** Attention should be made to circuit board design for effective heat dispersion and therefore, not allowing the LED joint temperature exceed the absolute maximum rated value.

*** In addition, the current should be determined shall be determined based on the Ambient Temperature surrounding the LED, and appropriate heat dissipation shall be implemented.

Static Electricity

*** It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs since Static electricity or surge voltage may potentially damage the LEDs.

*** It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs, where all related devices, equipment and machinery must be properly grounded.

*** It is recommended to check whether the assembled LEDs are damaged by static electricity during final product inspection in which LEDs were assembled. Recommend conducting a functional test with rated V_F and low 1mA current to find static-damaged LEDs.

*** Damaged LEDs may behave such as the leak current is significantly increased, the forward voltage becomes is reduced, or the LEDs do not light with the low test current. CRITERIA: ($V_F > 2.0V$ at $I_F=0.5mA$)

Cleaning

*** It is recommended to use isopropyl alcohol for cleaning the LEDs. Shall be confirmed beforehand if other solvents can be utilized to verify if the package or the resin can be negatively impacted. Freon solvents should not be used to clean the LEDs due to worldwide regulations.

*** Do not clean the LEDs by ultrasonic means. If absolutely necessary, a pre-test should be performed to confirm whether any damage to the LEDs may occur before proceeding to clean. Ultrasonic cleaning impact on the LEDs may be impacted by factors such as ultrasonic power and the assembled conditions.

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